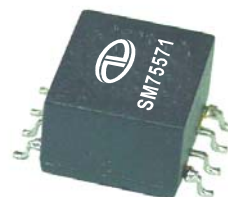




TELECOM MAGNETICS SM75571

Features

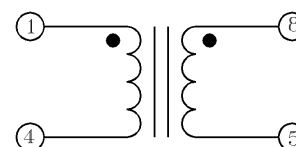
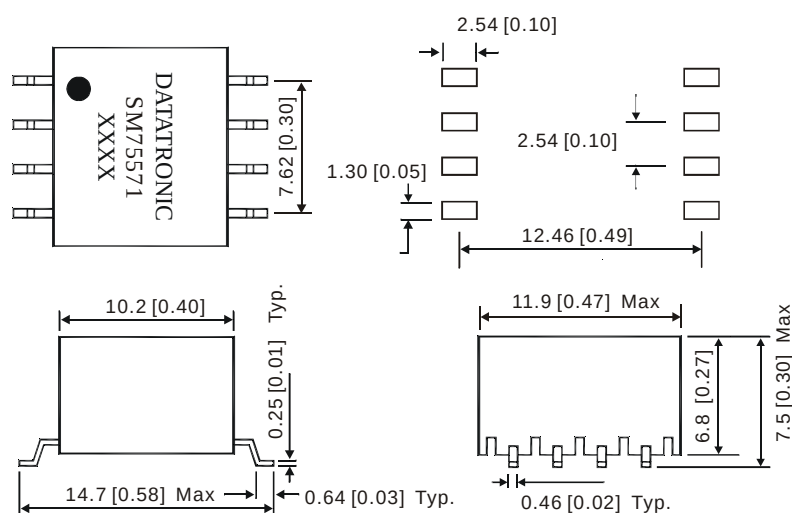
- Designed for use Conexant SMART HCF FFI Chipset
- UL1950 / EN60950 and BABT approved
- SMT package



ELECTRICAL SPECIFICATIONS AT 25°C

URNS RATIO (1-4) : (5-8)	1 : 2±2%
OCL @100kHz, 1V (1-4)	40μH MIN
LEAKAGE INDUCTANCE @4MHz, 1V	7μH MAX
INTERWINDING CAPACITANCE @1MHz	10pF MAX
DCR (1-4)	0.2Ω MAX
DCR (5-8)	0.4Ω MAX
HIPOT PRIMARY & SECONDARY 1 MINUTE	1500VRMS

OUTLINE DIMENSIONS



SCHEMATIC

Notes:

1. All dimensions are in mm [inches] and typical unless otherwise specified.
2. For non-RoHS parts consult factory for special part numbers.